SLVS019F - OCTOBER 1987 - REVISED JULY 1999

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- RESET Defined When V_{CC} Exceeds 1 V
- Wide Supply-Voltage Range . . . 3.5 V to 18 V
- Precision Overvoltage and Undervoltage Sensing
- 250-mA Peak Output Current for Driving SCR Gates
- 2-mA Active-Low SCR Gate Drive for False-Trigger Protection
- Temperature-Compensated Voltage Reference
- True and Complementary Reset Outputs
- Externally Adjustable Output Pulse Duration

DW OR N PACKAGE (TOP VIEW) 1RESIN Γ 16 VCC 15 2RESIN 1CT □ 1RESET **∏** 3 14 7 2CT 13 1 2RESET 1RESET 1 4 12 2RESET 1VSU **1** 5 11 | 2VSU 1VSO 10 2VSO 1SCR DRIVE 7 9 7 2SCR DRIVE GND [

description

The TL7770 is an integrated-circuit system supervisor designed for use as a reset controller in microcomputer and microprocessor power-supply systems. This device contains two independent supply-voltage supervisors that monitor the supplies for overvoltage and undervoltage conditions at the VSO and VSU terminals, respectively. When V_{CC} attains the minimum voltage of 1 V during power up, the \overline{RESET} output becomes active (low). As V_{CC} approaches 3.5 V, the time-delay function activates, latching RESET and \overline{RESET} active (high and low, respectively) for a time delay (t_d) after system voltages have achieved normal levels. Above $V_{CC} = 3.5$ V, taking \overline{RESIN} low activates the time-delay function during normal system-voltage levels. To ensure that the microcomputer system has reset, the outputs remain active until the voltage at VSU exceeds the threshold value, V_{IT+} , for a time delay, which is determined by an external timing capacitor such that:

$$t_d \approx 20 \times 10^3 \times capacitance$$

where t_d is in seconds and capacitance is in farads.

The overvoltage-detection circuit is programmable for a wide range of designs. During an overvoltage condition, an internal silicon-controlled rectifier (SCR) is triggered, providing 250-mA peak instantaneous current and 25-mA continuous current to the SCR gate drive terminal, which can drive an external high-current SCR gate or an overvoltage-warning circuit.

The TL7770C series is characterized for operation from 0° C to 70° C. The TL7770I series is characterized for operation from -40° C to 85° C.



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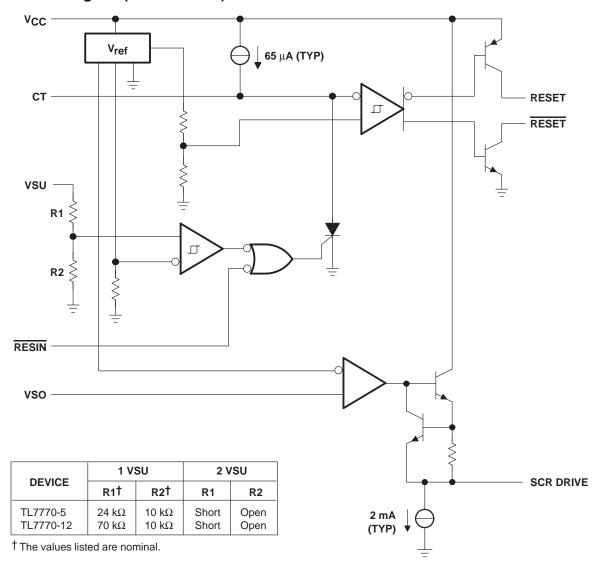


AVAILABLE OPTIONS

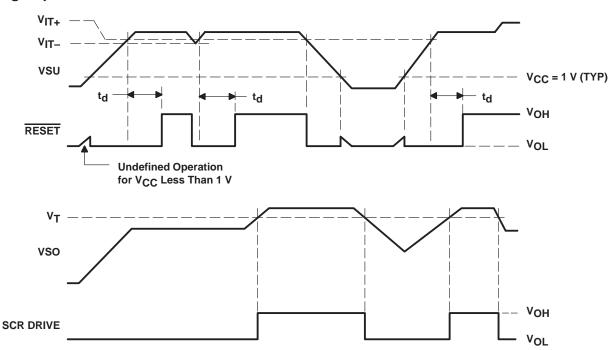
	PACKAGED	CHIP FORM	
TA	SMALL OUTLINE (DW)		
0°C to 70°C	TL7770-5CDW TL7770-12CDW	TL7770-5CN TL7770-12CN	TL7770-5Y TL7770-12Y
-40°C to 85°C	TL7770-5IDW	TL7770-5IN	_

DW package is available taped and reeled. Add the suffix R to the device type (e.g., TL7770-5CDWR). Chip forms are tested at 25°C.

functional block diagram (each channel)



timing requirements



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	20 V
Input voltage range, V _I : 1VSU, 2VSU, 1VSO, and 2VSO (see Note 1)	
Low-level output current (1RESET and 2RESET), IOL	20 mA
High-level output current (1RESET and 2RESET), IOH	–20 mA
Package thermal impedance, θ _{JA} (see Notes 2 and 3): DW package	57°C/W
N package	88°C/W
Lead temperature 1,6 mm (1/16 in) from case for 10 seconds: DW or N package	260°C
Storage temperature range, T _{sta}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.
 - 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 - 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



TL7770-5, TL7770-12 DUAL POWER-SUPPLY SUPERVISORS

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recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V _{CC}		3.5	18	V
Input voltage range, V _I (see Note 4)	1VSU, 2VSU, 2VSO, 1VSO	0	18	V
Output voltage, VO (1CT, 2CT)			5	V
High-level input voltage range, V _{IH} (1RESIN, 2RESIN)			18	V
Low-level input voltage range, V _{IL} (1RESIN, 2RESIN)			0.8	V
Output sink current, IO (1CT, 2CT)			50	μΑ
High-level output current, IOH (1RESET, 2RESET)			-16	mA
Low-level output current, I _{OL} (1RESET, 2RESET)			16	mA
Continuous output current, IO (1SCR DRIVE, 2SCR DRIVE)			25	mA
Timing capacitor, C _T			10	μF
Operation from air temperature T.	TL7770C series	0	70	°C
Operating free-air temperature, T _A	TL7770I series	-40	85	°C

NOTE 4: The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.



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electrical characteristics over recommended operating conditions (unless otherwise noted) supply supervisor section

	PARAMETER		TEST CONDITIONS†	TL7770-5C TL7770-12C TL7770-5I			UNIT	
				MIN	TYP‡	MAX		
V0	High-level output voltage	RESET	I _{OH} = -15 mA	V _{CC} -1.5			V	
VOH	r light-level output voltage	SCR DRIVE	$I_{OH} = -20 \text{ mA}$	V _{CC} -1.5			V	
VOL	Low-level output voltage	RESET	I _{OL} = 15 mA			0.4	V	
	VIT- Undervoltage input threshold at VSU (negative-going)	TL7770-5 (5-V sense, 1VSU)		4.46		4.64		
VIT		TL7770-12 (12-V sense, 1VSU)	$T_A = MIN \text{ to MAX}$	10.68		11.12	V	
VII-		TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47		1.53	v	
		TL7770-5 (5-V sense, 1VSU)		15 T _A = MIN to MAX				
\ \/.	Hysteresis at VSU	TL7770-12 (12-V sense, 1VSU)	TA - MINI to MAY				mV	
Vhys	(V _{IT+} – V _{IT} _)	TL7770-5, TL7770-12 (programmable sense, 2VSU)	TA = WIIN to WAX		5		IIIV	
VT	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	$T_A = MIN \text{ to } MAX$	2.48		2.68	V	
1.	Input current	RESIN	V _I = 5.5 V or 0.4 V			-10		
1	input current	VSO	V _I = 2.4 V		0.5	2	μΑ	
ІОН	High-level output current	RESET	V _O = 18 V			50	μΑ	
loL	Low-level output current	RESET	V _O = 0			-50	μΑ	
ЮН	Peak output current	SCR DRIVE	Duration = 1 ms	250			mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.

total device

PARAMETER		TEST CONDITIONS†			TL7770-5C TL7770-12C TL7770-5I		
				MIN	TYP‡	MAX	
V _{res} §	Power-up reset voltage	V _{CC} = VSU			0.8	1	V
loo	Supply current	1 <u>VSU</u> = 18 V, 2 <u>VSU</u> = 2 V, 1RESIN and 2RESIN at V _{CC} ,	T _A = 25°C			5	mA
Icc	Зирріу сипепі		$T_A = MIN \text{ to } MAX$			6.5	IIIA

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.



 $[\]ddagger$ Typical values are at VCC = 5 V, TA = 25°C.

[‡] Typical values are at $V_{CC} = 5 \text{ V}$, $T_{\underline{A}} = 25^{\circ}\text{C}$. § This is the lowest voltage at which RESET becomes active.

TL7770-5, TL7770-12 **DUAL POWER-SUPPLY SUPERVISORS**

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electrical characteristics over recommended operating conditions (unless otherwise noted) supply supervisor section

	PARAMETER			TL7770-5Y TL7770-12Y			UNIT	
				MIN	TYP	MAX		
		TL7770-5 (5-V sense, 1VSU)		4.46		4.64		
V _{IT} — Undervoltage input threshold (negative-going)	Undervoltage input threshold at VSU	TL7770-12 (12-V sense, 1VSU)	$T_A = MIN \text{ to MAX}$	10.68		11.12	V	
	(negative-going)	TL7770-5, TL7770-12 (programmable sense, 2VSU)	TA = WIIIV to WIAX	1.47		1.53		
		TL7770-5 (5-V sense, 1VSU)			15			
V/ha	Hysteresis at VSU	TL7770-12 (12-V sense, 1VSU)	$T_A = MIN \text{ to MAX}$		36		mV	
Vhys (V _{IT+} - V _{IT} -)		TL7770-5, TL7770-12 (programmable sense, 2VSU)	I A = WIII to Will UK		5		1111	
VT	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	$T_A = MIN \text{ to MAX}$	2.48		2.68	V	
Ц	Input current	VSO	V _I = 2.4 V		0.5		μΑ	

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

total device

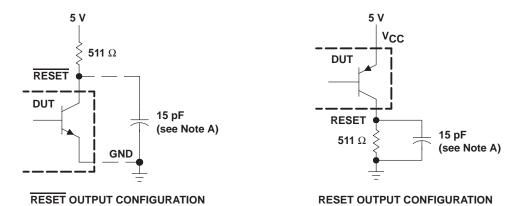
	PARAMETER	TEST COND	DITIONS		L7770-5\ .7770-12		UNIT
				MIN	TYP [†]	MAX	
V _{res} ‡	Power-up reset voltage	V _{CC} = VSU,	$V_{OL} = 0.4 \text{ V}, I_{OL} = 1 \text{ mA}$		0.8		V
Icc	Supply current	1 <u>VSU</u> = 18 V, 2 <u>VSU</u> = 2 V, 1 <u>RESIN</u> and 2 <u>RESIN</u> at V _{CC} , 1VSO and 2VSO at 0 V	T _A = 25°C			5	mA

switching characteristics, V_{CC} = 5 V, C_T open, T_A = 25°C

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
tPLH	Propagation delay time, low-to-high-level output	RESIN	RESET			270	500	ns	
^t PHL	Propagation delay time, high-to-low-level output	RESIN	RESET			270	500	ns	
t _r	Rise time		RESET	RESET	See Figures 1			75	20
tf	Fall time	I KEGET			and 3		150		ns
t _r	Rise time		DECET			75		20	
t _f	Fall time		RESET	RESET				50	ns
t (Minimum effective pulse duration	RESIN		See Figure 2a		150		ns	
^t w(min)	Minimum effective pulse duration	VSU		See Figure 2b		100		115	

[†] Typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ This is the lowest voltage at which RESET becomes active.

PARAMETER MEASUREMENT INFORMATION



NOTE A: This includes jig and probe capacitance.

Figure 1. RESET and RESET Output Configurations

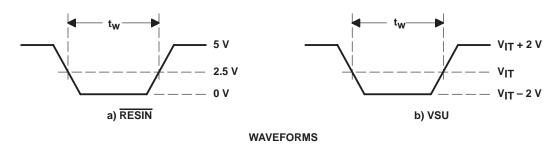


Figure 2. Input Pulse Definition

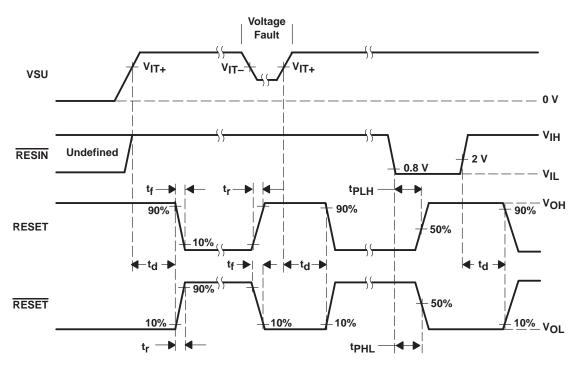
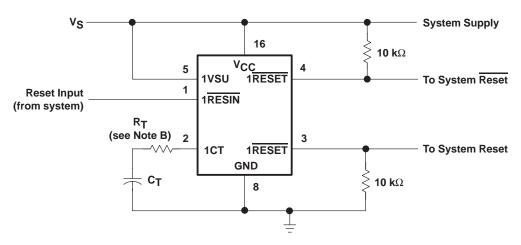


Figure 3. Voltage Waveforms



APPLICATION INFORMATION



NOTE B: When V_{CC} and 1VSU are connected to the same point, it is recommended that series resistance (R_T) be added between the time-delay programming capacitor (C_T) and the voltage-supervisor device terminal (1CT). The suggested R_T value is given by:

$$R_T > \frac{V_I - V_{IT-}}{1 \times 10^{-3}}$$
, where $V_I = \left(\text{the lesser of 7.1 V or V}_S \right)$

When this series resistor is used, the $t_{\mbox{\scriptsize d}}$ calculation is as follows:

$$t_{d} = \frac{1.3 - \left[((6.5 E - 5) \times 10^{-5}) \times R_{T} \right]}{6.5 \times 10^{-5}} \times C_{T}$$

Figure 4. System Reset Controller With Undervoltage Sensing

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